



(11) **EP 2 700 867 A8**

(12) **CORRECTED EUROPEAN PATENT APPLICATION**

(15) Correction information:
Corrected version no 1 (W1 A1)
Corrections, see
Bibliography INID code(s) 71

(51) Int Cl.:
F21S 4/00 ^(2006.01) **F21V 31/04** ^(2006.01)
F21Y 101/02 ^(2006.01)

(48) Corrigendum issued on:
28.05.2014 Bulletin 2014/22

(43) Date of publication:
26.02.2014 Bulletin 2014/09

(21) Application number: **13187742.5**

(22) Date of filing: **19.12.2008**

(84) Designated Contracting States:
**AT BE BG CH CY CZ DE DK EE ES FI FR GB GR
HR HU IE IS IT LI LT LU LV MC MT NL NO PL PT
RO SE SI SK TR**

(30) Priority: **21.12.2007 US 16307**

(62) Document number(s) of the earlier application(s) in
accordance with Art. 76 EPC:
08867610.1 / 2 235 430

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Remarks:
This application was filed on 08-10-2013 as a
divisional application to the application mentioned
under INID code 62.

(54) **Low profile flexible cable lighting assemblies and methods of making same**

(57) The present invention relates to a method of making a cable lighting assembly, said method comprising providing a flexible electrical cable (47) comprising an electrical conductor (45) insulated by electrical insulation; providing a light emitting diode (43) comprising a light emitting die mounted on a heat slug (53) and electrically connected to an anode lead (55) and a cathode lead (57); said method further comprising removing a por-

tion of the electrical insulation to expose at least one surface mounting area on the surface of the electrical conductor (45) of the flexible electrical cable (47), soldering the heat slug (53) of the light emitting diode (3) to the mounting area of the conductor (45) on which either the anode lead (55) or the cathode lead (57) is soldered.

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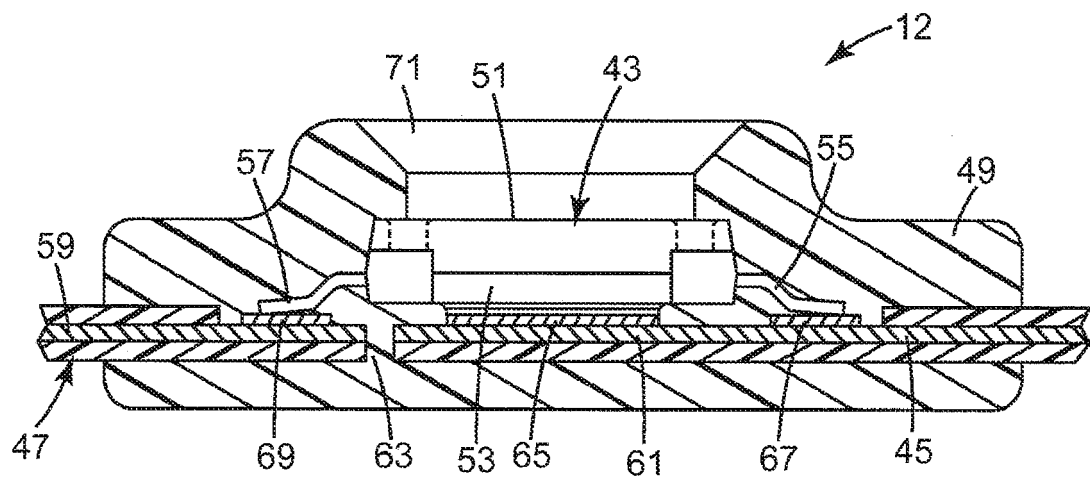


Fig. 4